

### FEATURES

- Available as "HR" (high reliability) screened per MIL-PRF-19500, JANTX level. Add "HR" suffix to base part number.
- Available as non-RoHS (Sn/Pb plating), standard, and as RoHS by adding "-PBF" suffix.

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
<b>Peak repetitive off-state voltage<sup>(1)</sup></b> ( $T_j = -40$ to $+110^\circ\text{C}$ , sine wave, 50 to 60Hz, gate open)			
MCR72-1		25	
MCR72-2		50	
MCR72-3	$V_{DRM}$	100	V
MCR72-4	$V_{RRM}$	200	
MCR72-5		300	
MCR72-6		400	
MCR72-7		500	
MCR72-8		600	
<b>On-state RMS current</b> (180° conduction angles, $T_c = 83^\circ\text{C}$ )	$I_{T(RMS)}$	8.0	A
<b>Peak non-repetitive surge current</b> (half-cycle, sine wave, 60Hz, $T_j = 110^\circ\text{C}$ )	$I_{TSM}$	100	A
<b>Circuit fusing consideration</b> ( $t = 8.3\text{ms}$ )	$I^2t$	40	$\text{A}^2\text{s}$
<b>Forward peak gate voltage</b> ( $t \leq 10\mu\text{s}$ , $T_c = 83^\circ\text{C}$ )	$V_{GM}$	$\pm 5.0$	V
<b>Forward peak gate current</b> ( $t \leq 10\mu\text{s}$ , $T_c = 83^\circ\text{C}$ )	$I_{GM}$	1.0	A
<b>Forward peak gate power</b> (pulse width $\leq 10\mu\text{s}$ , $T_c = 83^\circ\text{C}$ )	$P_{GM}$	5.0	W
<b>Average gate power</b> ( $t = 8.3\text{ms}$ , $T_c = 83^\circ\text{C}$ )	$P_{G(AV)}$	0.75	W
<b>Operating junction temperature range</b>	$T_j$	-40 to +110	$^\circ\text{C}$
<b>Storage temperature range</b>	$T_{stg}$	-40 to +150	$^\circ\text{C}$
<b>Mounting torque</b>	-	8.0	In. lb.

Note 1:  $V_{DRM}$  and  $V_{RRM}$  for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

### THERMAL CHARACTERISTICS

Characteristic	Symbol	Maximum	Unit
<b>Thermal resistance, junction to case</b>	$R_{\theta JC}$	2.2	$^\circ\text{C}/\text{W}$
<b>Thermal resistance, junction to ambient</b>	$R_{\theta JA}$	60	$^\circ\text{C}/\text{W}$
<b>Lead solder temperature</b> (lead length 1/8" from case, 10s max)	$T_L$	260	$^\circ\text{C}$

### ELECTRICAL CHARACTERISTICS ( $T_J = 25^\circ\text{C}$ unless otherwise specified)

Characteristic	Symbol	Min	Typ	Max	Unit
<b>OFF CHARACTERISTICS</b>					
<b>Peak forward or reverse blocking current<sup>(2)</sup></b> ( $V_{AK} = \text{Rated } V_{DRM} \text{ or } V_{RRM}, R_{GK} = 1\text{k}\Omega$ ) $T_C = 25^\circ\text{C}$ $T_C = 110^\circ\text{C}$	$I_{DRM}$ $I_{RRM}$	- -	- -	10 500	$\mu\text{A}$
<b>ON CHARACTERISTICS</b>					
<b>Peak forward on-state voltage</b> ( $I_{TM} = 16\text{A}$ , pulse width $\leq 1\text{ms}$ , duty cycle $\leq 2\%$ )	$V_{TM}$	-	1.7	2.0	V
<b>Gate trigger current (continuous dc)<sup>(3)</sup></b> ( $V_D = 12\text{V}$ , $R_L = 100\Omega$ )	$I_{GT}$	-	30	200	$\mu\text{A}$
<b>Gate trigger voltage (continuous dc)<sup>(3)</sup></b> ( $V_D = 12\text{V}$ , $R_L = 100\Omega$ )	$V_{GT}$	-	0.5	1.5	V
<b>Gate non-trigger voltage</b> ( $V_D = 12\text{V}$ , $R_L = 100\Omega$ , $T_J = 110^\circ\text{C}$ )	$V_{GD}$	0.1	-	-	V
<b>Holding current</b> ( $V_D = 12\text{V}$ , gate open, initiating current = 200mA)	$I_H$	-	-	6.0	mA
<b>Gate controlled turn-on time</b> ( $V_D = \text{Rated } V_{DRM}$ , $I_{TM} = 16\text{A}$ , $I_G = 2\text{mA}$ )	$t_{gt}$	-	1.0	-	$\mu\text{s}$
<b>DYNAMIC CHARACTERISTICS</b>					
<b>Critical rate of rise of off-state voltage</b> ( $V_D = \text{rated } V_{DRM}$ , $R_{GK} = 1\text{k}\Omega$ , $T_J = 110^\circ\text{C}$ , exponential waveform)	$dv/dt$	-	10	-	$\text{V}/\mu\text{s}$

Note 2: Ratings apply for negative gate voltage or  $R_{GK} = 1\text{k}\Omega$ . Devices shall not have a positive gate voltage concurrently with a negative voltage on the anode. Devices should not be tested with a constant current source for forward and reverse blocking capability such that the voltage applied exceeds the rated blocking voltage.

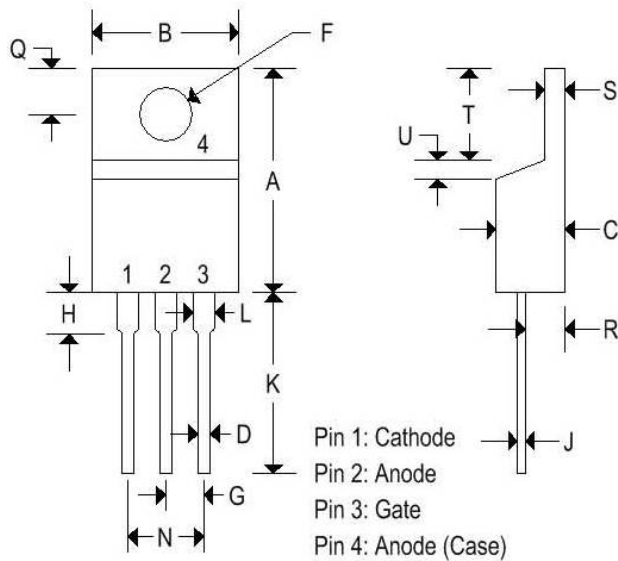
Note 3:  $R_{GK}$  current not included in measurement.

# MCR72 SERIES

## SILICON CONTROLLED RECTIFIERS

### MECHANICAL CHARACTERISTICS

Case:	TO-220AB
Marking:	Body painted, alpha-numeric
Pin out:	See below



	TO-220AB			
	Inches		Millimeters	
	Min	Max	Min	Max
A	0.575	0.620	14.600	15.750
B	0.380	0.405	9.650	10.290
C	0.160	0.190	4.060	4.820
D	0.025	0.035	0.640	0.890
F	0.142	0.147	3.610	3.730
G	0.095	0.105	2.410	2.670
H	0.110	0.155	2.790	3.930
J	0.014	0.022	0.360	0.560
K	0.500	0.562	12.700	14.270
L	0.045	0.055	1.140	1.390
N	0.190	0.210	4.830	5.330
Q	0.100	0.120	2.540	3.040
R	0.080	0.110	2.040	2.790
S	0.045	0.055	1.140	1.390
T	0.235	0.255	5.970	6.480
U	-	0.050	-	1.270
V	0.045	-	1.140	-
Z	-	0.080	-	2.030

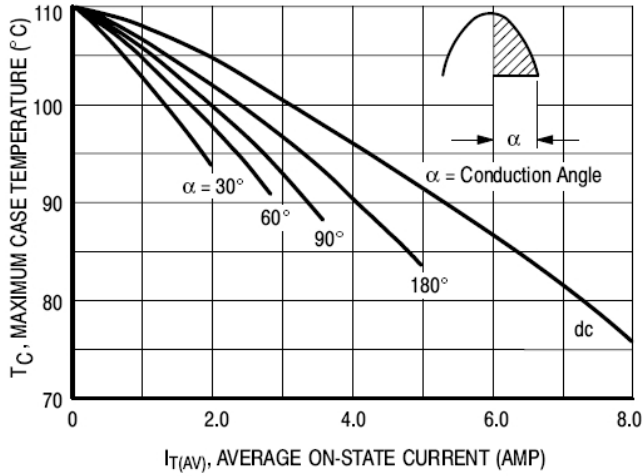


Figure 1. Average Current Derating

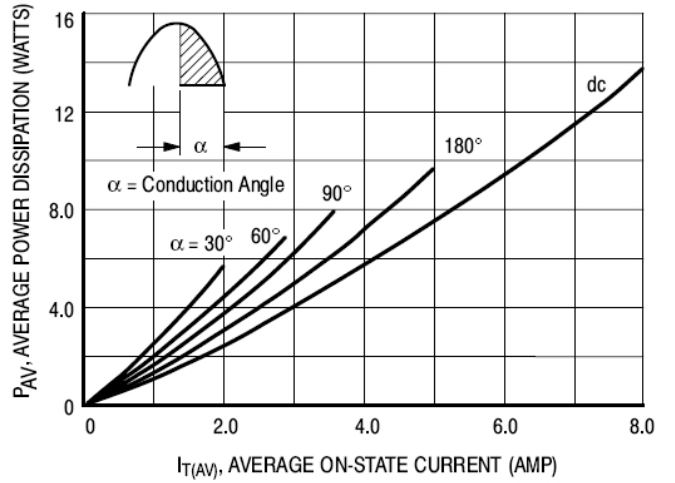


Figure 2. On-State Power Dissipation

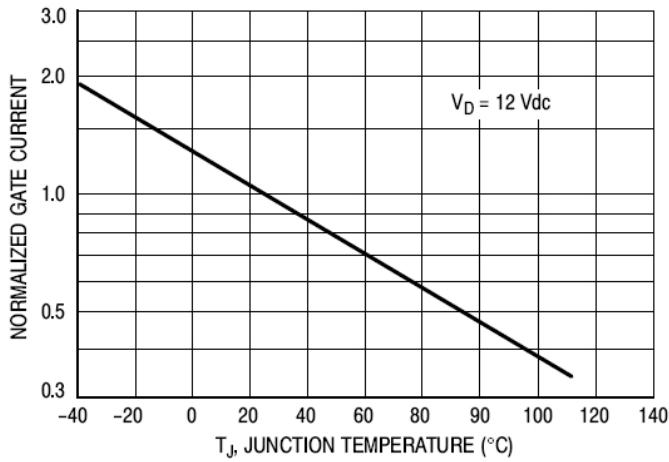


Figure 3. Normalized Gate Current

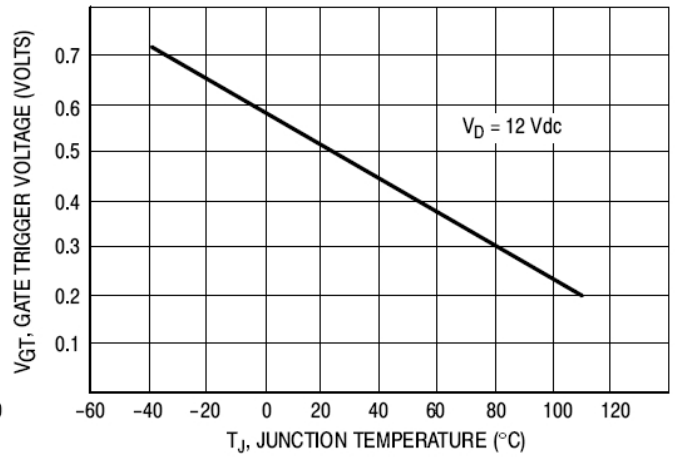


Figure 4. Gate Voltage